



Docket No.: 1155-0271P  
(PATENT)

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Patent Application of:  
Masahiro SAWADA et al.

Application No.: 10/607,519

Confirmation No.: 6031

Filed: June 27, 2003

Art Unit: 1711

For: POLYAMIDE RESIN COMPOSITION AND  
MOLDED ARTICLE THEREOF

Examiner: A. L. Woodward

*do NOT  
enter  
AW  
7/05*

**AMENDMENT AFTER FINAL ACTION (37 C.F.R. SECTION 1.116)**

MS AF  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

**INTRODUCTORY COMMENTS**

In response to the Office Action dated March 7, 2005, finally rejecting claims 1-6, the period for reply being extended one (1) month to July 7, 2005, please amend the above-identified U.S. patent application as follows:

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper.

**Remarks/Arguments** begin on page 4 of this paper.